Application Serial No.: 10/749,255 Preliminary Amendment dated June 17, 2004

Amendments to the Specification

Please add the following <u>new</u> paragraph immediately following the title of the application on page 1, as follows:

This application is a Continuation-In-Part of co-pending U.S. Patent Application Serial No. 10/712,444, filed on November 13, 2003, and entitled, "Thin-Film Deposition Methods and Apparatuses."